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PATENT APPLICATION Docket No. 11675.114

Group Art

Unit 1763

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Kei-Yu Ko

Serial No.: 08/846,671

Filed: April 30, 1997

For: UNDOPED SILICON DIOXIDE AS ETCH

STOP

FOR SELECTIVE ETCH OF DOPED SILICON DIOXIDE

Examiner: George A. Goudreau

RESPONSE TO ELECTION REQUIREMENT

The Honorable Commissioner of Patents and Trademarks
Washington, D. C. 20231

Sir:

In response to the Office Action dated on February 12, 2001 (the "Office Action") the Applicant submits this Response.

IN THE CLAIMS:

Marked up Version of the Pending Claims Under 37 C.F.R. § 1.121(c)(1)(ii):

A clean version of the pending claims pursuant to 37 C.F.R. § 1.121(c)(3) is provided hereinbelow after the following marked up version of the amended claims.

Please amend claim 33 as follows and in accordance with 37 C.F.R. § 1.121(c)(1)(ii), by

Response to Election Requirement Serial No.08/846,671